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Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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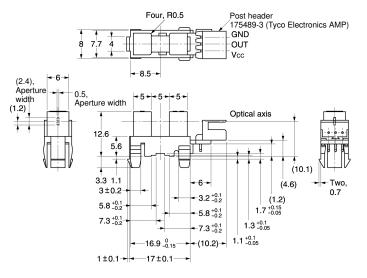


omron EE-SX3239-P2/-SX4239-P2

Photomicrosensor (Transmissive)

Dimensions

Note: All units are in millimeters unless otherwise indicated.



Note: The asterisked dimension is specified by datum A only.

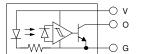
Internal Circuit

Terminal No.

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Name

Power supply (Vcc)

Output (OUT)

Ground (GND)

Unless otherwise specified, the tolerances are as shown below.

	Dimensions	Tolerance
	3 mm max.	±0.3
	3 < mm ≤ 6	±0.375
	$6 < mm \le 10$	±0.45
	$10 < mm \le 18$	±0.55
)	18 < mm ≤ 30	±0.65
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Recommended Mating Connectors:

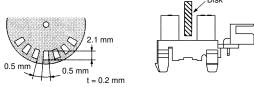
Tyco Electronics AMP 175778-3 (crimp-type connector)

173977-3 (press-fit connector)

■ Electrical and Optical Characteristics (Ta = 25°C, V_{CC} = 5 V ±10%)

Item	Symbol	Value	Condition	
Current consumption	I _{CC}	16.5 mA max.	With and without incident	
Low-level output voltage	V _{OL}	0.35 V max.	I _{OUT} = 16 mA without incident (EE-SX3239-P2), with incident (EE-SX4239-P2)	
High-level output voltage	V _{OH}	(V _{CC} x 0.9) V min.	$\label{eq:VOUT} \begin{array}{l} V_{\text{OUT}} = V_{\text{CC}} \text{ with incident (EE-SX3239-P2),} \\ \text{without incident (EE-SX4239-P2), } R_{\text{L}} = 47 \ \mathrm{k}\Omega \end{array}$	
Response frequency	f	3 kHz min.	$V_{OUT} = V_{CC}, R_L = 47 \text{ k}\Omega \text{ (see note)}$	

Note: The value of the response frequency is measured by rotating the disk as shown below.



Features

- Snap-in mounting model.
- Mounts to 1.0-, 1.2- and 1.6-mm-thick panels.
- High resolution with a 0.5-mm-wide sensing aperture.
- With a 5-mm-wide slot.
- Photo IC output signals directly connect with C-MOS and TTL.
- Connects to Tyco Electronics AMP's CT-series connectors.

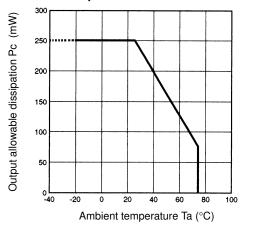
Absolute Maximum Ratings (Ta = 25°C)

lte	em	Symbol	Rated value
Power supply voltage		V _{CC}	7 V
Output voltage		V _{OUT}	28 V
Output current		I _{OUT}	16 mA
Permissible output dissipation		P _{OUT}	250 mW (see note)
Ambient temperature	Operating	Topr	–20°C to 75°C
	Storage	Tstg	–40°C to 85°C
Soldering temperature		Tsol	

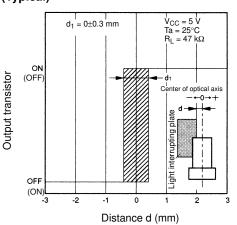
Note: Refer to the temperature rating chart if the ambient temperature exceeds 25°C.

Engineering Data

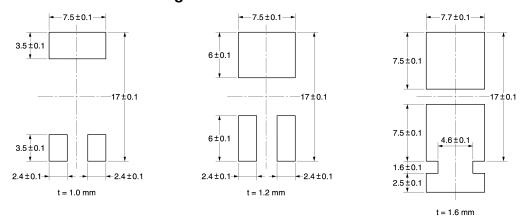
Output Allowable Dissipation vs. Ambient Temperature Characteristics



Sensing Position Characteristics (Typical)



Recommended Mounting Holes



- When mounting the Photomicrosensor to a panel with a hole opened by pressing, make sure that the hole has no burrs. The mounting strength of the Photomicrosensor will decrease if the hole has burrs.
- When mounting the Photomicrosensor to a panel with a hole opened by pressing, be sure to mount the Photomicrosensor on the pressing side of the panel.
- The mounting strength of the Photomicrosensor will increase if the Photomicrosensor is mounted to a panel with a hole that is only a little larger than the size of the Photomicrosensor, in which case, however, it will be difficult to mount the Photomicrosensor to the panel. The mounting strength of the Photomicrosensor will decrease if the Photomicrosensor is mounted to a panel with a hole that is comparatively larger than the size of the Photomicrosensor, in which case, however, it will be easy to mount the Photomicrosensor to the panel. When mounting the Photomicrosensor to a panel, open an appropriate hole for the Photomicrosensor according to the application.
- After mounting the Photomicrosensor to any panel, make sure that the Photomicrosensor does not wobble.
- When mounting the Photomicrosensor to a molding with a hole, make sure that the edges of the hole are sharp enough, otherwise the Photomicrosensor may fall out.